

Strand Testing at Fermilab

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- o Limits of pressure contact setup
- Contributions to contact resistance (measured and calculated)
- New sample holders design and performance



Upgrade of Power Supply

LBNL-FNAL Collaboration Meeting

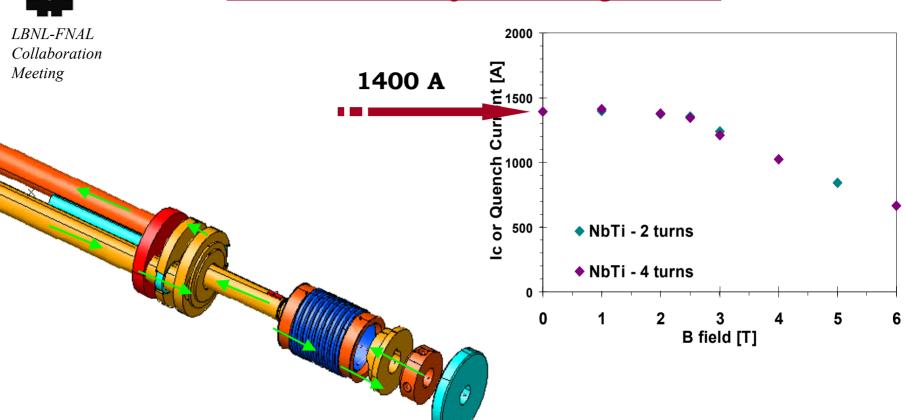
2 x 6680A AGILENT 895 A / 5 V DC PS IN PARALLEL

PS LIMIT = 1815 A





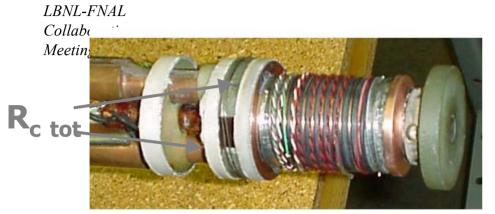
Limitations of Existing Probe

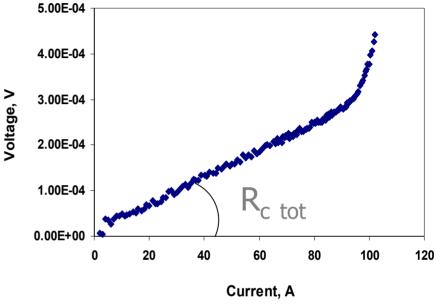


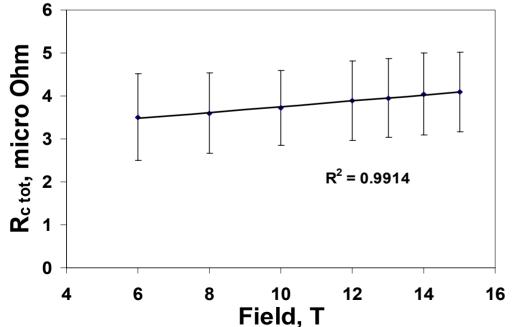
- **❖ Total contact resistance** ~ 4 µOhm
- * An estimate of the maximum allowed contact resistance to carry 2000 A \sim 1 μ Ohm



Total Contact Resistance - Measurement







R_{c tot} averaged over 34 samples as a function of field

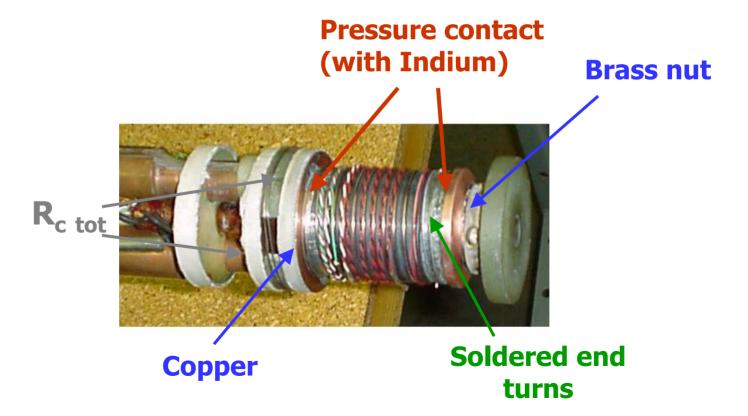
(Spread given by the root mean square of the distributions)



Total Contact Resistance

Contributions

$$R_{C \text{ tot}} = \sum R_{Cu, Brass, In} + \sum R_{soldered turns} + \sum R_{Press. contact}$$





Contact Resistance - Calculation



Soldered contact

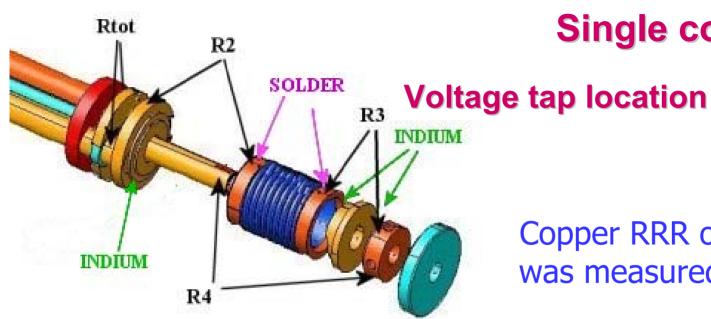
$$r = \frac{\rho_{Solder, 4.2K} \cdot t_{Solder}}{\pi \cdot \phi_{Solder}} = 0.0316 \cdot 10^{-9} \Omega \cdot m$$

$$R = \frac{\rho_{Cu,4.2K}}{\pi \cdot \phi_{Cu} \cdot t_{Cu}} 0.01448 \cdot 10^{-4} \Omega / m$$

Number of turns	L (mm)	R _{Junction} $(n\Omega)$	
2	2	17	
4	4	9.8	
8	8	7.2	



Contact Resistance – Measurements



Single contributions

Copper RRR of probe was measured = 113

	MEAGUEED	OTHER CONTRIBUTIONS (Calculated at 4.2 K)			CONTACT
R	MEASURED at 4.2 K	COPPER	INDIUM	BRASS	RESISTANCE
[OHM]	40 1.2 11	ρ _{Cu} =1.48E-10 † m	ρ _{In} =3.11E- 10 † m	ρ _{Br} =6 E-8 † m	(CORRECTED FROM R)
R2	1.38E-07	1.45E-09	1.35E-10	No brass	1.36E-07
R3	3.22E-07	7.27E-10	2.80E-10	1.38E-07	1.83E-07
R4	2.81E-06	1.98E-06	No In	1.77E-07	1.03E-06



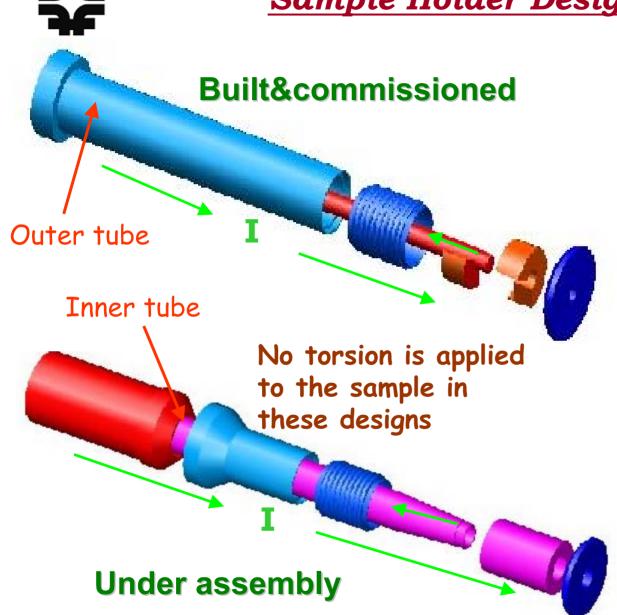
Comparison - Measurements vs. Calculations

LBNL-FNAL
Collaboration

Mosting LC.	MEAS.	CALC.	CALC.	MEAS.
R _{Soldered} turns 2 turns	R _{Soldered} turns 2 x 2 turns	R _{Pressure} contact Bearing area	R _{Pressure} contact Apparent area	R _{Pressure} contact With Indium
17 nΩ	34 nΩ	2.877 μΩ	0.161 μΩ	0.136 μΩ

- Excellent consistency was found between data and calculations
- By flowing within the contact surfaces, Indium makes the apparent area to be the actual contact area for current flow
- Pressure contact resistances are only about 1 order of magnitude larger than for soldered contacts

Sample Holder Designs



Soldered contact

- Sample ends soldered to copper lugs
- Expected contact resistance $< 40 \text{ n}\Omega$



Pressure contact

- Design with contact area ~ previous x4
- Expected contact resistance < 1 $\mu\Omega$

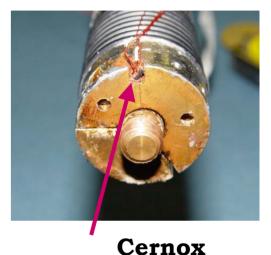




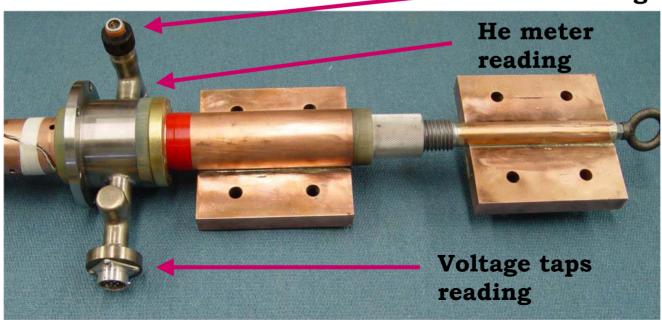
High Current Probe - Soldered contact

Instrumented sample





Cernox reading

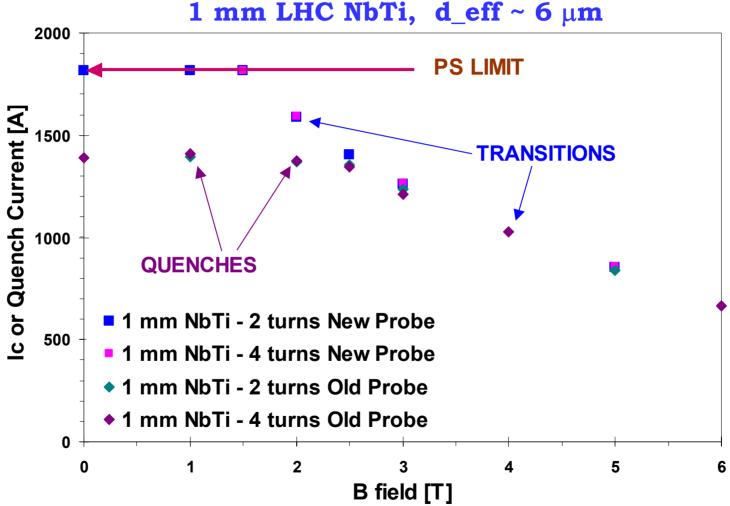


Licia Del Frate's Laurea Thesis



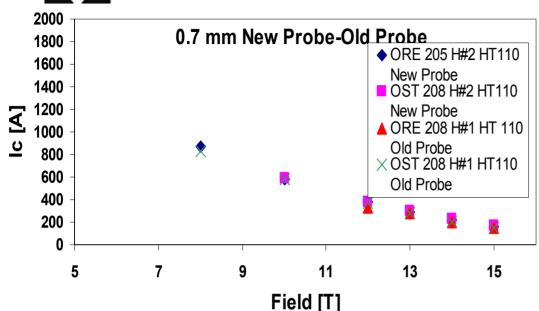
Measurements at Low Fields of Stable Strands

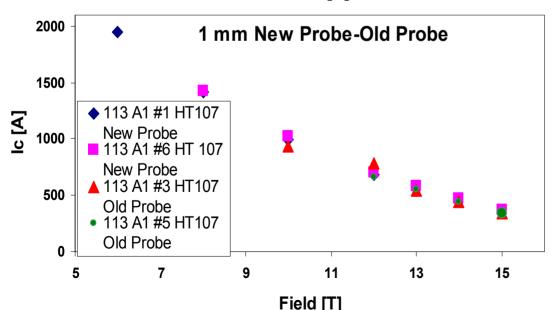
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<u>Comparison - Critical Current Values</u>

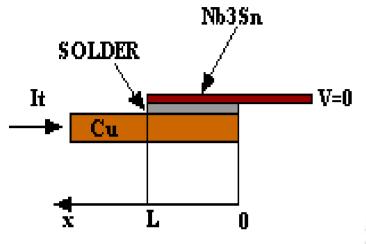




Conclusion – The I_{c} measurements performed with the new probe are consistent with the regular ones



Contact Resistance - Calculation

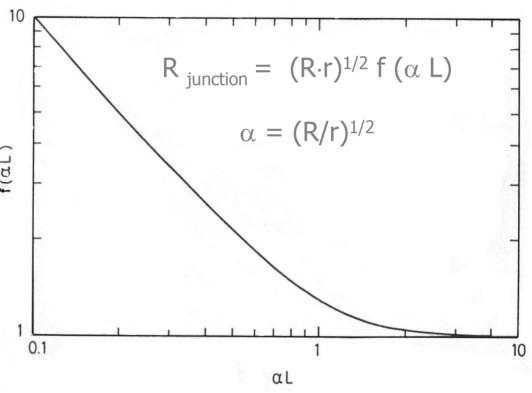


$$\begin{cases} V(x) = r \cdot \frac{dI(x)}{dx} \\ \frac{dV(x)}{dx} = I(x) \cdot R \end{cases}$$

r =Solder resistance · length

R = Cu resistance / length

Soldered contact



$$V(L) = I_t \cdot (R \cdot r)^{1/2} \cdot \frac{e^{\alpha L} + e^{-\alpha L}}{e^{\alpha L} - e^{-\alpha L}} = I_t \cdot (R \cdot r)^{1/2} \cdot f(\alpha L)$$



Contact Resistance - Calculation

Pressure contact

Force due to torque *T*

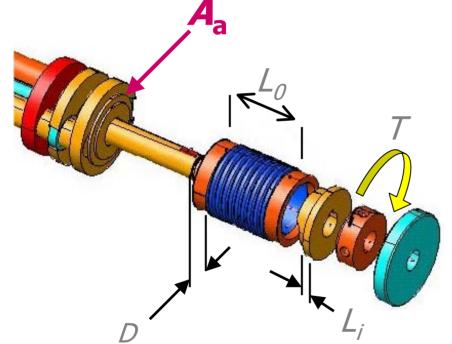
$$F = \frac{T}{0.2D} = 6667 N$$

Force due to differential thermal contraction δ



$$\begin{cases} L_{Cu} = L_{Ti} = L_0 = 34.9 \ mm \\ \varepsilon_{Cu} (293 - 4.2 \ K) = 0.32 \% \\ \varepsilon_{Ti} (293 - 4.2 \ K) = 0.15 \% \end{cases}$$

$$P = \frac{\delta}{\sum \frac{L_i}{A_i \cdot E_i}} = 364 \ N$$



Thread nominal diameter

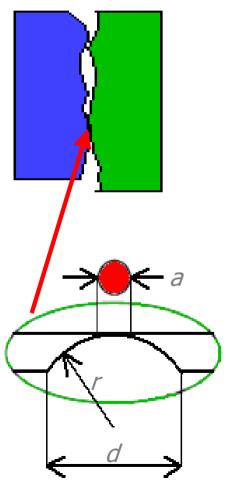
Total pressure on apparent area A_a

$$\bar{p}_a = \frac{F + P}{A_a} = 2.707 \cdot 10^7 \frac{N}{m^2}$$



Contact Resistance – Calculation

Contact



Actual contact area depends on pressure

From Hertz classic formulae on elastic deformation and contact surfaces, in the case of a sphere against a plane body of same material (with Poisson ratio = 0.3):

$$a = 1.11 \cdot \sqrt[3]{\frac{P_i}{E} \cdot r} = 5.807 \cdot 10^{-7} \ m$$

 $P_i = average \quad load / hump = \overline{p}_a d^2$

 $r = curvature \ radius \ of \ rugosity \ elevation = 4 \cdot 10^{-5} \ m$

Average pressure on a sphere
$$\bar{p} = \frac{\int_{0}^{a} \frac{1.5 \cdot P_{i}}{\pi \cdot a^{3}} \cdot \sqrt{a^{2} - x^{2}} \cdot dx}{a} = 4.816 \cdot 10^{8} \cdot \frac{N}{m^{2}}$$

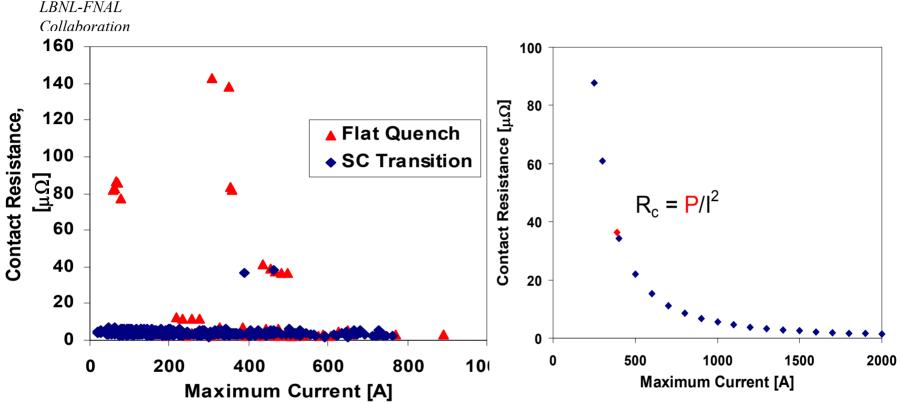
Bearing area A_b

$$A_b = \frac{1}{17.795} \cdot A_a$$

From constriction resistance of a circular conducting surface against a plane body (Kottler, Smythe):



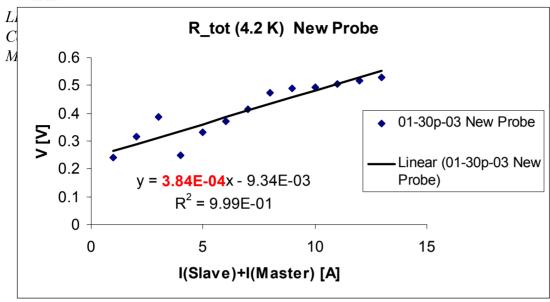
Effect of Contact Resistance Extrapolation to 2000 A

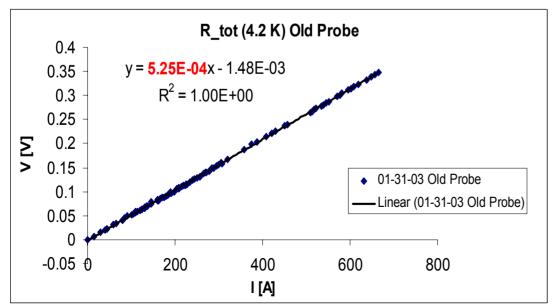


Conclusion - The maximum contact resistance at 2000 A is about 1 $\mu\Omega$, which is 1/4 of present FNAL holder (~ 4 μ Ω)



Comparison - Total Resistance of the Probes





Conclusion - The total resistance of the new probe (without SC splices yet) is already ~ 70% that of the old probe